

### QT625C XO DETAIL SPECIFICATION

#### **Specification Control Drawing**

#### Scope

Scope Part Number

#### **Applicable Documents**

Specifications and Standards

#### Requirements

General Requirements Approved Manufacturer Design and Construction Outline Dimensions and Terminal Connections Package Body and Lead Finish Active Devices Use of National Semiconductor Corporation (NSC) Radiation Hard CMOS Performance Requirements Maximum Ratings Electrical Performance Characteristics and Limits Delta Limits Total Dose Radiation Limits

#### **Quality Assurance Provisions**

General Screening Tests Quality Conformance Inspection

#### Packaging

Preservation, Packaging and Packing

#### Notes

Ordering Information Part Number **Table I.** Stability/Temperature Options

#### **Source of Supply**

Approved Manufacturer

Table II. Maximum Ratings

Table III. Electrical Performance Characteristics

Figure. 1. Package Dimensions and Terminal Connections

			к	EVISIONS				
REVISION		D	ESCRIPTIC	ON		DATE		APPROVE
-	Initial release							
А	Include parag	raph 3.3.3.1 clarification o	f microcircuit te	echnology, SEL rat	ing	7/17/07	,	
В	Clarification,	2/14/08	;					
С	Change to mi	8/04/08	;					
D	Clarification,	paragraph 3.3.3.1. Add HC	CMOS logic opt	tion.		8/27/08	;	E.Jackson
		CUMENT IS COI COPY OR DISTF						
SPECIF	FICATION	I CONTROL DRA	AWING					
SPECIF	FICATION	I CONTROL DRA	AWING DATE	Q-TECH C 10150 W.		DN I BLVD.		
UNLESS OTH	HERWISE NSIONS ARE		_	Q-TECH C 10150 W. CULVER (	JEFFERSON CITY, CA. 90	DN I BLVD. 0232-3510		
UNLESS OTH SPECIFIED DIMEI IN INCH	HERWISE NSIONS ARE IES.	PREPARED BY	DATE	Q-TECH C 10150 W. CULVER C	JEFFERSON CITY, CA. 90 CRYSTAL C	DN I BLVD. 0232-3510 0SCILLATO	9R +5	V, CLASS
UNLESS OTH	HERWISE NSIONS ARE IES. ICES: MAL = .005	PREPARED BY E.Jackson CHECKED BY	DATE 8/27/08 DATE	Q-TECH C 10150 W. CULVER C	JEFFERSON CITY, CA. 90 CRYSTAL C	DN I BLVD. 0232-3510	9R +5	V, CLASS
UNLESS OTH SPECIFIED DIMEI IN INCH TOLERAN 3 PLACE DECI	HERWISE NSIONS ARE IES. ICES: MAL = .005 IMAL = .02	PREPARED BY E.Jackson	DATE 8/27/08	Q-TECH C 10150 W. CULVER C	JEFFERSON CITY, CA. 90 CRYSTAL C	DN I BLVD. 0232-3510 0SCILLATO	9R +5	V, CLASS
UNLESS OTH SPECIFIED DIMEI IN INCH 3 PLACE DECI 2 PLACE DECI 1 PLACE DEC FRACTIONS	HERWISE NSIONS ARE IES. ICES: IMAL = .005 IMAL = .02 CIMAL = .1 = ± 1/16	PREPARED BY E.Jackson CHECKED BY	DATE 8/27/08 DATE	Q-TECH C 10150 W. CULVER C HYBRID C	JEFFERSON CITY, CA. 90 CRYSTAL C DETAIL SP	DN I BLVD. 0232-3510 0SCILLATO	9R +5	V, CLASS OR
UNLESS OTH SPECIFIED DIMEI IN INCH TOLERAN 3 PLACE DECI 2 PLACE DECI 1 PLACE DECI 1 PLACE DECI	HERWISE NSIONS ARE IES. ICES: IMAL = .005 IMAL = .02 CIMAL = .1 = ± 1/16	PREPARED BY E.Jackson CHECKED BY T.Villegas	DATE 8/27/08 DATE 10/9/08	Q-TECH C 10150 W. CULVER C HYBRID C DRAWING NO.	JEFFERSON CITY, CA. 90 CRYSTAL C DETAIL SP QT6	ON I BLVD. 0232-3510 OSCILLATO ECIFICATIO	9R +5	V, CLASS OR
UNLESS OTH SPECIFIED DIMEI IN INCH 3 PLACE DECI 2 PLACE DECI 1 PLACE DEC FRACTIONS	HERWISE NSIONS ARE IES. ICES: IMAL = .005 IMAL = .02 CIMAL = .1 = ± 1/16	PREPARED BY E.Jackson CHECKED BY T.Villegas	DATE 8/27/08 DATE 10/9/08	Q-TECH C 10150 W. CULVER C HYBRID C	JEFFERSON CITY, CA. 90 CRYSTAL C DETAIL SP	ON I BLVD. 0232-3510 OSCILLATO ECIFICATIO	9R +5' ON FO	V, CLASS OR

#### 1 SCOPE

- 1.1 <u>Scope.</u> This specification establishes the detail requirements for hybrid, hermetically sealed, crystal oscillators for use in space flight missions.
- 1.2 <u>Part number.</u> The part number shall be as specified in Table I herein.

#### 2 APPLICABLE DOCUMENTS

2.1 <u>Specifications and standards.</u> Unless otherwise specified, the following documents shall be applicable to this specification to the extent specified herein.

#### **SPECIFICATIONS**

401-0298-001 Hybrid Crystal C

Hybrid Crystal Oscillators, Class S, General Specification For

#### 3 REQUIREMENTS

- 3.1 <u>General requirements.</u> The individual item requirements shall be as specified in the General Specification with the exceptions, modifications, and additions specified herein.
- 3.2 <u>Approved manufacturer.</u> Hybrid crystal oscillators shall be supplied from the manufacturer specified in paragraph 7.1 herein.
- 3.3 Design and construction.
- 3.3.1. <u>Outline dimensions and terminal connections.</u> The outline dimensions and terminal connections shall be as shown in Figure 1 herein.
- 3.3.2. <u>Package body and lead finish.</u> The package body and lead finish shall be gold in accordance with MIL-PRF-38534.
- 3.3.3. <u>Active Devices.</u> The microcircuit used in this part shall use CMOS technology and shall be from a wafer proven to be radiation tolerant to 100 kRad (Si) total ionizing dose.
- 3.3.3.1 <u>CMOS microcircuit usage.</u> For frequencies below 12 MHZ the output microcircuit shall be Intersil Corporation 54ACS/HCS family, Silicon on Sapphire CMOS technology. For frequencies greater than or equal to 12 MHZ, the CMOS microcircuit shall be 54AC00, see DSSC SMD 5962-87549. This microcircuit is specified to be *single event latchup free* for LET up to 93 MeV-cm<sup>2</sup>/mg. For output frequencies from 12 MHZ to 100 MHZ, the manufacturer shall be ST Microelectronics Corporation; for output frequencies greater than 100 MHZ, the manufacturer shall be National Semiconductor Corporation
- 3.4 <u>Performance requirements.</u>
- 3.4.1. <u>Maximum ratings.</u> The maximum ratings shall be as specified in Table II herein.
- 3.4.2. <u>Electrical performance characteristics and limits.</u> The electrical performance requirements and limits shall be in accordance with Table III herein.
- 3.4.3. <u>Delta limits.</u> Except for frequency aging (refer to Table III), delta limits shall be in accordance with the General Specification.
- 3.4.4. <u>Total dose radiation limits.</u> Hybrid crystal oscillators supplied in accordance with this specification shall be capable of meeting the performance requirements after being exposed to 100 krad total dose radiation levels.

#### 4 QUALITY ASSURANCE PROVISIONS

- 4.5 <u>General.</u> The quality assurance provisions shall be in accordance with the General Specification with the exceptions, modifications, and additions specified herein.
- 4.6 <u>Screening tests.</u> The screening tests shall be in accordance with the General Specification.
  4.7 <u>Quality Conformance Inspection.</u> Quality Conformance Inspection shall be in accordance with the General Specification and shall be required only when specified by the purchase order.

#### 5 PACKAGING

5.1 <u>Preservation, packaging and packing.</u> Hybrid crystal oscillators shall be prepared for delivery in accordance with the General specification.

#### 6 NOTES

- 6.1 <u>Notes.</u> The notes of the General Specification are applicable to this drawing.
- 6.2 <u>Ordering information.</u> The procuring activity shall advise Q-Tech Corporation at the time of Request for Quotation if quality conformance inspection is to be required.
- 6.3 Part number.

<u>QT625</u> <u>C</u> <u>B</u> <u>1</u> <u>M</u> - <u>16.000000 MHZ</u>

Model #
Supply voltage: C: + 5.0 volts
Temp stability - see Table I
Duty cycle: 1: 60/40%
2: 45/55% (available up to 100MHz)
Screening: E: engineering model; M: flight model

Frequency (8 digits)

TABLE I. STABILITY / TEMPERATURE OPTIONS					
OPTION	TEMP STABILITY				
Α	± 65 PPM, - 55 °C TO + 125 °C				
В	± 50 PPM, - 55 °C TO + 125 °C				
С	± 50 PPM, - 55 °C TO + 105 °C				
D	± 40 PPM, - 55 °C TO + 105 °C				
E	± 30 PPM, - 40 °C TO + 85 °C				
F	± 50 PPM, - 20 °C TO + 70 °C				
G	± 25 PPM, - 20 °C TO + 70 °C				
H *	± 5 PPM, 0 °C TO + 55 °C				

\* Frequency/Temperature stability (tolerance) shall be referenced to the specified nominal output frequency, except for temp code H, in which case it is with reference to room temperature (T =  $25 \pm 2$  °C). For temp code H, room temperature tolerance shall be  $\pm 10$  PPM.

### 7 SOURCE OF SUPPLY

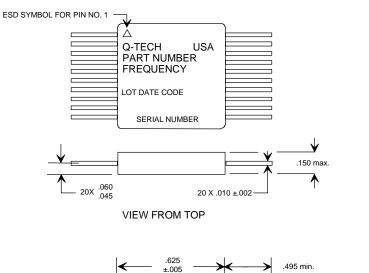
7.1 <u>Approved manufacturer.</u>

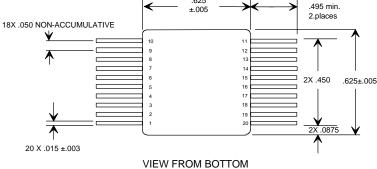
Q-Tech Corporation 10150 W. Jefferson Blvd. Culver City, Ca. 90232 U.S.A.

	Parameter		Symbol	Min		Max	Un	its	
S	Supply voltage		V <sub>cc</sub>	0		7	Vc	olts	
0	perating temperature		Tc	-55		125		С	
	torage temperature		Tstg	-65		150		С	
	ead solder temperature/time					250/10		conds	
Pa	ackage thermal resistance		θјс			50	°C	/W	
	TABLE III. ELE	CTRI			HARAG	TERIST	CS		
ELECT	LECTRICAL PARAMETER		<b>FEST CONDITIONS 2/,3/</b>		LIMITS				NOTES
					MIN.	NOM.	MAX.	UNITS	
FREQUENCY	RANGE				0.05		150	MHz	
FREQUENCY	TEMPERATURE STABILITY				See Table I			1/, 4/	
SUPPLY VOL	TAGE				4.5	5	5.5	Vdc	
	INPUT CURRENT		out frequency:				•		
Measured without load at 5.5 Vdc		Less than 12 MHZ					12	mA	
		12 MHZ - 59.99 MHZ					25	mA	
		60 MHZ - 99.99 MHZ					45	mA	
		100 MHZ - 150 MHZ				60	mA		
LOAD						CMOS		-	6/
OUTPUT VOL	TAGE - LOGIC "0"						V <sub>cc</sub> x 0.1	Vdc	5/
OUTPUT VOLTAGE - LOGIC "1"					V <sub>cc</sub> x 0.9			Vdc	
OUTPUT WAVEFORM					Squarewave N/A		N/A		
RISE / FALL TIME (worst case, @Vcc = 4.5, and T = 125 °C)		Outp	out frequency:						
		B	elow 12 MHZ				7	nS	6/
		12 MHZ - 80 MHZ					3.5	nS	6/
		>	80 MHZ				2.5	nS	6/
DUTY CYCLE		C	Option 1:		60/40 or better			%	
		Option 2: (<= 100 MHz)		45/55 or better			%		
FREQUENCY AGING (AFTER 30 DAYS)			70 °C ± 3°	C	±1.5 p		ppm		
FREQUENCY	AGING (AFTER 1 YEAR)		70 °C ± 3°	C			±10	ppm	
STARTUP TIME							10	ms	

#### <u>NOTES</u>

- 1. The limit for frequency/temperature stability (tolerance) shall be referenced to the specified nominal output frequency.
- 2. Unless otherwise specified the limits are over the full operating temperature range, under specified load conditions and at nominal supply voltage.
- 3. Unless otherwise specified, all measurements are in accordance with MIL-PRF-55310.
- 4. Up to 30 days after shipment.
- 5. Voltage values are with respect to network ground terminal.
- 6. A standard CMOS load of 10 kOhm || 15 pF shall be used. See MIL-PRF-55310/26 for CMOS waveform measurement definitions.





#### NOTES:

- 1. Dimensions are in inches.
- 2. Lead numbers are for reference only and are not marked on the unit.
- 3. All pins with function NC may not be connected as external tie or connections, except they may be tied to Ground.

TERMINAL CONNECTIONS								
TERMINAL NO.	CONNECTION	TERMINAL NO.	CONNECTION					
1	N/C	11	OUTPUT					
2	N/C	12	GND/CASE *					
3	N/C	13	V <sub>cc</sub>					
4	N/C	14	N/C					
5	N/C	15	GND/CASE *					
6	N/C	16	N/C					
7	N/C	17	N/C					
8	N/C	18	N/C					
9	N/C	19	N/C					
10	GND/CASE	20	N/C					

\* Additional optional Ground connections are included only when microcircuit used is 54AC00 (see paragraph 3.3.3.1), and may be connected to circuit ground plane for minimum overshoot/ringing when driving capacitive loads.

### FIGURE 1. PACKAGE DIMENSIONS AND TERMINAL CONNECTIONS

**Q-Tech Corporation** 10150 W. Jefferson Blvd. Culver City, CA. 90232